In Re the Specification

Please replace the entire **DETAILED DESCRIPTION OF THE EMBODIMENTS** with the replacement section shown below. Both a marked version illustrating the changes to the **DETAILED DESCRIPTION OF THE EMBODIMENTS** section and a clean version have been provided.

Marked version illustrating changes

[0012] Referring now to the drawings, in which like numerals represent like elements or steps throughout the several views, FIG. 1 illustrates a block diagram representation of a system 100 that may contain a processor 105, a memory controller 110130, and a stacked memory array 115, which may contain a first memory array 120110A and a second memory array 120110B. The memory controller 110130 may act as an interface to control the flow of data between the processor 105 and the stacked memory array 115. The memory controller 110130 may be configured to sequence two write state machines 125105A and 125105B and to program the stacked memory array 115 having the first memory array 120110A and the second memory array 120110B in accordance with some embodiments of the present invention.

[0013] The first Mmemory array 120110A and the second memory array 120110B may typically comprise arrays of memory cells. In an exemplary embodiment, the first memory array 120110A and the second memory array 120110B may be stacked vertically such that the second memory array 120110B may be physically on top of the first memory array 120110A. In an exemplary embodiment, the memory arrays 120110 may typically be NOR flash memory arrays; however, those skilled in the art will appreciate that other types of memory arrays, including but not limited to, NAND flash memory, random access memory ("RAM"), static random access memory ("SRAM"), and the like may be used without deviating from the scope of the embodiments of the present invention. Although the stacked memory array 115 may be

described in terms of two memory arrays, those skilled in the art will appreciate that the number of memory arrays 420110 is not limited and may contain any number of individual memory arrays 420110 without departing from the scope of the embodiments of the present invention.

[0014] In an exemplary embodiment, Tethe write state machines 425105A, 425105B may be the internal controllers of the individual memory arrays 110A, 110B, respectively. The write state machines 425105A, 105B may be operable to follow an algorithm to program the individual memory arrays 420110 by using pulses of current from a pulse generator 430120.

[0015] The memory controller 110130 may also include the pulse generator 130120 that may be operable to generate a waveform containing a series of current pulses, which may be supplied to the write state machines 125105A, 105B. The pulse generator 130120 may also communicates with a delay circuit 135125 that may be operable to inject a time delay between a first pulse of current applied to the first write state machine 125105A and a second pulse of current applied to the second write state machine 125105B.

FIG. 2 illustrates a prior—art waveform 200 including a plurality of pulses of current that may be generated by the pulse generator 130120 and applied to the write state machines 125105A, 105B. The waveform 200 may begin, in time, with a short initial pulse 205 of current having a large amplitude, which may typically be used to initiate a write or erase operation to the individual memory cell and also to supply the majority of the current to the cell of the stacked memory array 120115. In an exemplary embodiment, the initial pulse 205 may have an amplitude of 25.4 milliamperes for approximately 1 microsecond, and may have a pulse width of approximately 2 microseconds.

[0017] After the initial pulse 205, there may be a period of time, or a delay 210, during which time the system 100 may read what current is on each cell of the stacked memory array 120A115. In an exemplary embodiment, the delay 210 may be approximately 7 microseconds long at 3 milliamperes. After the delay 210, there may be a second pulse 215, which may be used to supply additional current to the write state machine 105A, 105B. Unlike the initial pulse 205, this second pulse 215 may have a peak amplitude that is less than the pulse amplitude of the initial pulse 205. In an exemplary embodiment, the peak amplitude may have a plateau at 10.6 milliamperes and a pulse width of approximately 30 microseconds, with a rise time of approximately 2 microseconds. After this second pulse 215, there may be a plurality of additional brief delays 220 with smaller pulses 225 therebetween. In an exemplary embodiment, the plurality of brief delays 220 with smaller pulses 225 therebetween may include three brief delays 220 and three pulses 225. During the brief delays 220 the system 100 may read the voltage on the individual cells of the stacked memory array 120A115. Each brief delay 220 may last for approximately 2 microseconds at about 4 milliamperes. The three pulses 225 may indicate when additional current is being supplied to the write state machine 125. Each of the three pulses 225 may last for approximately 22 microseconds at 10.6 milliamperes.

[0018] After the plurality of additional brief delays 220 and pulses 225, there may be a second delay 230, which may permit the system 100 to verify if there is enough voltage on each cell of the stacked_memory array 120A115. The second delay 230, in an exemplary embodiment, may last for about 20 microseconds at 2 milliamperes. If the memory controller 110130 determines that enough voltage has not been built up within the memory cell, then an additional plurality of pulses 225, which are shown in the dashed line in the figure, may be

generated by the pulse generator \$\frac{130120}{120}\$ to increase the voltage on the cells of the stacked memory array \$\frac{1200115}{120}\$ to the appropriate value.

Although an exemplary prior art—waveform 200 having a plurality of pulses therein has been described as having certain properties, including amplitudes and durations of individual pulses, those skilled in the art will appreciate that pulses of current having other amplitudes and durations, may be applied individually or in combination to the write state machines 425105A, 105B, which may create other waveforms that are within the scope of the embodiments of the present invention. For example, another waveform within the scope of the embodiments of the present invention may have a series of pulses therein, wherein all pulses may be of equal amplitude, duration, and period, such as the waveforms depicted in FIG. 6.

total flow diagram illustrating a routine 300 of sequencing multiple write state machines 125105A, 105B according to some embodiments of the present invention. Starting at 310, the pulse generator 130120 may apply current, in the form of the first initial pulse 205A, to the first write state machine 125105A. At 320, the delay circuit 135125 may inject a time-delay At into the system 100 so that the initial pulse 205B applied to the second write state machine 125105B may occur during the time of the delay 210A of after the first initial pulse is supplied to the first write state machine 125105A in accordance with an exemplary embodiment of the present invention.

10024HIn an alternative second exemplary embodiment, at 320, the delay circuit 135125 may inject a time-delay Δt into the system 100 so that the initial pulse 205B applied to the second write state machine 125105B may occur during the time of the delay 230A-between the first plurality of three brief delays 220A and pulses 225A and the second plurality of brief delays

220A and pulses 225A applied to the first write state machine 125A. By applying the initial pulses 205B during either the delay 210A or the delay 230A, the peaks of the initial pulses 205A and 205B may not align in time, thereby allowing the system 100 to accommodate all current without incorporating a larger voltage regulator.

He011H[0020]. Then at 330, the pulse generator 430[20] may apply current to the next write state machine 105, which in an exemplary embodiment may be the second write state machine 105B. In an exemplary embodiment, the amount of time-delay Δt may be at least as long as the amount of time of the first initial pulse 205 applied to the first write state machine 105A of the first waveform 200A so as to prevent the initial pulses 205 applied to the first write state machine 105A, in the form of the waveform 200, generated by the pulse generator 130 from occurring simultaneously or during the rise and fall interval of the first initial pulse 205 applied to the second first—write state machine 105AB. Thus, in an exemplary embodiment, the second waveform may be offset from the first waveform by at least 2 microseconds. This may assure that the initial pulses 205 of the first waveform 200A and the second waveform 200B applied to the first write state machine 105A and the second write state machine 105B do not line up, thereby minimizing the amount of current needed to generate waveforms 200 to the first and second memory arrays 120110A. 120110B.

<u>190424[0021]</u> Although the routine 300 has been described with respect to two write state machines $+25\underline{105}$ A, $\underline{105}$ B, those skilled in the art will appreciate that the routine 300 may be applied to any number of write state machines +25, such that there may be a time-delay Δt between subsequent pulses of current applied to subsequent write state machines $+25\underline{105}$ A, 105B.

[0013][0022] FIG. 4 is a timing diagram illustrating a pair of current waveforms 200400A, 200400B for programming thea stacked memory array 115 in accordance with one embodiment of the present invention. In an exemplary embodiment, the pulse generator 130120 may apply the first pulse 205405A of current of the plurality of pulses, which together may form the first waveform 200400A, to the first write state machine 125105A. Then, the delay circuit 135125 may inject a time-delay Δt 407 before the pulse generator 130120 may apply a first pulse 205405B of the plurality of pulses, which together may form the second waveform 200400B, to the second write state machine 425105B. Thus, in an exemplary embodiment, the initial pulse 205405A of the first waveform 200400A may be applied to the first write state machine 125105A and then the initial pulse 205405B of the second waveform 200400B may be applied to the second write state machine 425105B at a time of at least 2 microseconds after the initial pulse 295405A of the first waveform 200400A. Therefore, in an exemplary embodiment, the second initial pulse 205405B may occur during the time of the first delay 210410 of the first waveform 200400A, and thus, in an exemplary embodiment, the second waveform 200400B may be delayed a period equal to Δt 497. Those skilled in the art will appreciate that the length of the time-delay Δt 407 between the first waveform 200400A and the second waveform 200400B may be in the range of microseconds so that the entire second initial pulse 205405B may occur during the first delay 210410 in the waveform 200400A having a plurality of pulses applied to the first write state machine 125105A.

100141[0023] FIG. 5 is a timing diagram illustrating a pair of current waveforms 200500A, 200500B for programming a stacked memory array 115 in accordance with another embodiment of the present invention. In an exemplary embodiment, the pulse generator 130120 may apply the first pulse 205505A of current of the plurality of pulses, which together may form the first

waveform 200505A, to the first write state machine 125105A. Then, the delay circuit 135125 may inject a time-delay Δt_507 before the pulse generator 130120 may apply a first pulse 205505B of the plurality of pulses, which together may form the second waveform 200500B, to the second write state machine 125105B. Thus, the initial pulse 205505A of the first waveform 200505A may be applied to the first write state machine 125105A and then the initial pulse 205505B of the second waveform 200500B may be applied to the second write state machine 125105B at some time after the initial pulse 205505A of the first waveform 200500A. Therefore, in an exemplary embodiment, the second initial pulse 205505B may occur during the time of the second delay 230530 of the first waveform 200500A, and thus, in an exemplary embodiment, the second waveform 200500B may be delayed a period equal to Δt_507. Those skilled in the art will appreciate that the length of time the second waveform 200500B may be delayed may be in the range of 93 microseconds to 111 microseconds so that the entire second initial pulse 205505B may occur during the second delay 230530 in the waveform 200500A having a plurality of pulses applied to the first write state machine 125105A.

190541 Also, those skilled in the art will appreciate the length of time that the second waveform 200500B may be delayed may be other amounts of time so long as that when the total amount of current in the system 100 is aggregated, the voltage regulator may accommodate the aggregated current. Thus, it may be within the scope of the embodiments of the present invention to delay the second initial pulse 205505B that may be applied to the second write state machine 125105B such that a portion of the second initial pulse 205505B may overlap a portion of the first initial pulse 205505A that may be applied to the first write state machine 125105A.

Because in some exemplary embodiments, the peak amplitudes of the two initial pulses 205505A

and 505B may not occur simultaneously, a standard voltage regulator may accommodate the total current of the system 100 at any given time.

<u>10016H0025I</u> In exemplary embodiments, the time delay Δt <u>507</u> between the first waveform <u>200500</u>A and the second waveform <u>200500</u>B may be between 2 and 1111 microseconds, which may create a minimal delay in the amount of time the system <u>100</u> requires to program the <u>stacked</u> memory arrays <u>120115</u>, as compared to the seconds added if the write state machines <u>125105</u> were to be programmed sequentially. Additionally, by creating a time-delay Δt <u>507</u> between the two waveforms <u>200505A</u> and <u>505B</u> applied to the two write state machines <u>125105</u>, the overall cost of manufacturing and operating the system <u>100</u> may decrease as compared to the cost of manufacturing and operating a system in which the write state machines <u>125105</u> are programmed in parallel (i.e., simultaneously). This is due in part to the fact that in many cases, a new regulator should be added to the system to accommodate the larger amounts of current and in part to the fact that a lesser amount of current may be applied simultaneously.

10017-[10026] FIG. 6 is a timing diagram illustrating a pair of current waveforms 600<u>A and 600B</u> for programming a stacked memory array 115 in accordance with still another embodiment of the present invention. Waveforms 600<u>A and 600B</u> may include a series of pulses 605 therein wherein all pulses 605 may be of equal amplitude, duration, and period. In an exemplary embodiment, the pulse generator 130120 may apply the first pulse 605A₁ of current of the first waveform 600A, to the first write state machine 125105A. Then, the delay circuit 135125 may inject a time-delay Δt before the pulse generator 130120 may apply a first pulse 605B₁ of current of the second waveform 600B to the second write state machine 125105B. Therefore, in an exemplary embodiment, the second initial pulse 605B₁ may occur during the time of a first delay

 $610A_1$ of the first waveform 600A, and thus, in an exemplary embodiment, the second waveform 600B may be delayed a period equal to Δt .

[0027] Other alternative embodiments will become apparent to those skilled in the art to which an exemplary embodiment pertains without departing from its spirit and scope. Accordingly, the scope of the embodiments of the present invention may be defined by the appended claims rather than the foregoing description.

Clean version

Referring now to the drawings, in which like numerals represent like elements or steps throughout the several views, FIG. 1 illustrates a block diagram representation of a system 100 that may contain a processor 105, a memory controller 130, and a stacked memory array 115, which may contain a first memory array 110A and a second memory array 110B. The memory controller 130 may act as an interface to control the flow of data between the processor 105 and the stacked memory array 115. The memory controller 130 may be configured to sequence two write state machines 105A and 105B and to program the stacked memory array 115 having the first memory array 110A and the second memory array 110B in accordance with some embodiments of the present invention.

[0013] The first memory array 110A and the second memory array 110B may typically comprise arrays of memory cells. In an exemplary embodiment, the first memory array 110A and the second memory array 110B may be stacked vertically such that the second memory array 110B may be physically on top of the first memory array 110A. In an exemplary embodiment, the memory arrays 110 may typically be NOR flash memory arrays; however, those skilled in the art will appreciate that other types of memory arrays, including but not limited to, NAND flash

memory, random access memory ("RAM"), static random access memory ("SRAM"), and the like may be used without deviating from the scope of the embodiments of the present invention. Although the stacked memory array 115 may be described in terms of two memory arrays, those skilled in the art will appreciate that the number of memory arrays 110 is not limited and may contain any number of individual memory arrays 110 without departing from the scope of the embodiments of the present invention.

[0014] In an exemplary embodiment, the write state machines 105A, 105B may be the internal controllers of the individual memory arrays 110A, 110B, respectively. The write state machines 105A, 105B may be operable to follow an algorithm to program the individual memory arrays 110 by using pulses of current from a pulse generator 120.

[0015] The memory controller 130 may also include the pulse generator 120 that is operable to generate a waveform containing a series of current pulses, which may be supplied to the write state machines 105A, 105B. The pulse generator 120 also communicates with a delay circuit 125 that is operable to inject a time delay between a first pulse of current applied to the first write state machine 105A and a second pulse of current applied to the second write state machine 105B.

[0016] FIG. 2 illustrates a waveform 200 including a plurality of pulses of current that may be generated by the pulse generator 120 and applied to the write state machines 105A, 105B. The waveform 200 may begin, in time, with a short initial pulse 205 of current having a large amplitude, which may be used to initiate a write or erase operation to the individual memory cell and also to supply the majority of the current to the cell of the stacked memory array 115. In an exemplary embodiment, the initial pulse 205 may have an amplitude of 25.4

milliamperes for approximately 1 microsecond, and may have a pulse width of approximately 2 microseconds

[0017]After the initial pulse 205, there may be a period of time, or a delay 210, during which time the system 100 may read what current is on each cell of the stacked memory array 115. In an exemplary embodiment, the delay 210 may be approximately 7 microseconds long at 3 milliamperes. After the delay 210, there may be a second pulse 215, which may be used to supply additional current to the write state machine 105A, 105B. Unlike the initial pulse 205, this second pulse 215 may have a peak amplitude that is less than the pulse amplitude of the initial pulse 205. In an exemplary embodiment, the peak amplitude may have a plateau at 10.6 milliamperes and a pulse width of approximately 30 microseconds, with a rise time of approximately 2 microseconds. After this second pulse 215, there may be a plurality of additional brief delays 220 with smaller pulses 225 therebetween. In an exemplary embodiment, the plurality of brief delays 220 with smaller pulses 225 therebetween may include three brief delays 220 and three pulses 225. During the brief delays 220 the system 100 may read the voltage on the individual cells of the stacked memory array 115. Each brief delay 220 may last for approximately 2 microseconds at about 4 milliamperes. The three pulses 225 may indicate when additional current is being supplied to the write state machine 125. Each of the three pulses 225 may last for approximately 22 microseconds at 10.6 milliamperes.

After the plurality of additional brief delays 220 and pulses 225, there may be a second delay 230, which may permit the system 100 to verify if there is enough voltage on each cell of the stacked memory array 115. The second delay 230, in an exemplary embodiment, may last for about 20 microseconds at 2 milliamperes. If the memory controller 130 determines that enough voltage has not been built up within the memory cell, then an additional plurality of

pulses 225, which are shown in the dashed line in the figure, may be generated by the pulse generator 120 to increase the voltage on the cells of the stacked memory array 115 to the appropriate value.

[0019] Although waveform 200 h has been described as having certain properties, including amplitudes and durations of individual pulses, those skilled in the art will appreciate that pulses of current having other amplitudes and durations, may be applied individually or in combination to the write state machines 105A, 105B, which may create other waveforms that are within the scope of the embodiments of the present invention. For example, another waveform within the scope of the embodiments of the present invention may have a series of pulses therein, wherein all pulses may be of equal amplitude, duration, and period, such as the waveforms depicted in FIG. 6.

FIG. 3 is a logical flow diagram illustrating a routine 300 of sequencing multiple write state machines 105A, 105B according to some embodiments of the present invention. Starting at 310, the pulse generator 120 may apply current, in the form of a first initial pulse, to the first write state machine 105A. At 320, the delay circuit 125 may inject a time-delay Δt into the system 100 so that a initial pulse applied to the second write state machine 105B may occur after the first initial pulse is supplied to the first write state machine 105A in accordance with an exemplary embodiment of the present invention. In an alternative exemplary embodiment, at 320, the delay circuit 125 may inject a time-delay Δt into the system 100 so that the initial pulse applied to the second write state machine 105B may occur during the time of the delay between the first plurality of three brief delays and pulses and the second plurality of brief delays and pulses applied to the first write state machine 125A. Then at 330, the pulse generator 120 may apply current to the next write state machine, which in an exemplary embodiment may be the

second write state machine 105B. In an exemplary embodiment, the amount of time-delay Δt may be at least as long as the amount of time of the first initial pulse applied to the first write state machine 105A so as to prevent the initial pulse applied to the first write state machine 105A from occurring simultaneously or during the rise and fall interval of the first initial pulse applied to the second write state machine 105B. Thus, in an exemplary embodiment, the second waveform may be offset from the first waveform by at least 2 microseconds. This may assure that the initial pulses applied to the first write state machine 105A and the second write state machine 105B do not line up, thereby minimizing the amount of current needed to generate waveforms 200 to the first and second memory arrays 110A, 110B.

[0021] Although the routine 300 has been described with respect to two write state machines 105, those skilled in the art will appreciate that the routine 300 may be applied to any number of write state machines 105A, 105B, such that there may be a time-delay Δt between subsequent pulses of current applied to subsequent write state machines 105.

[0022] FIG. 4 is a timing diagram illustrating a pair of current waveforms 400A, 400B for programming the stacked memory array 115 in accordance with one embodiment of the present invention. In an exemplary embodiment, the pulse generator 120 may apply the first pulse 405A of current of the plurality of pulses, which together may form the first waveform 400A, to the first write state machine 105A. Then, the delay circuit 125 may inject a time-delay Δt 407 before the pulse generator 120 may apply a first pulse 405B of the plurality of pulses, which together may form the second waveform 400B, to the second write state machine 105B. Thus, in an exemplary embodiment, the initial pulse 405A of the first waveform 400A may be applied to the first write state machine 105A and then the initial pulse 405B of the second

waveform 400B may be applied to the second write state machine 105B at a time of at least 2 microseconds after the initial pulse 405A of the first waveform 400A. Therefore, in an exemplary embodiment, the second initial pulse 405B may occur during the time of the first delay 410 of the first waveform 400A, and thus, in an exemplary embodiment, the second waveform 400B may be delayed a period equal to Δt 407. Those skilled in the art will appreciate that the length of the time-delay Δt 407 between the first waveform 400A and the second waveform 400B may be in the range of microseconds so that the entire second initial pulse 405B may occur during the first delay 410 in the waveform 400A having a plurality of pulses applied to the first write state machine 105A.

[0023] FIG. 5 is a timing diagram illustrating a pair of current waveforms 500A, 500B for programming a stacked memory array 115 in accordance with another embodiment of the present invention. In an exemplary embodiment, the pulse generator 120 may apply the first pulse 505A of current of the plurality of pulses, which together may form the first waveform 505A, to the first write state machine 105A. Then, the delay circuit 125 may inject a time-delay Δt 507 before the pulse generator 120 may apply a first pulse 505B of the plurality of pulses, which together may form the second waveform 500B, to the second write state machine 105B. Thus, the initial pulse 505A of the first waveform 505A may be applied to the first write state machine 105A and then the initial pulse 505B of the second waveform 500B may be applied to the second write state machine 105B at some time after the initial pulse 505A of the first waveform 500A. Therefore, in an exemplary embodiment, the second initial pulse 505B may occur during the time of the second delay 530 of the first waveform 500A, and thus, in an exemplary embodiment, the second waveform 500B may be delayed a period equal to Δt 507. Those skilled in the art will appreciate that the length of time the second waveform 500B may be

delayed may be in the range of 93 microseconds to 111 microseconds so that the entire second initial pulse 505B may occur during the second delay 530 in the waveform 500A having a plurality of pulses applied to the first write state machine 105A.

Also, those skilled in the art will appreciate the length of time that the second waveform 500B may be delayed may be other amounts of time so long as that when the total amount of current in the system 100 is aggregated, the voltage regulator may accommodate the aggregated current. Thus, it may be within the scope of the embodiments of the present invention to delay the second initial pulse 505B that may be applied to the second write state machine 105B such that a portion of the second initial pulse 505B may overlap a portion of the first initial pulse 505A that may be applied to the first write state machine 105A. Because in some exemplary embodiments, the peak amplitudes of the two initial pulses 505A and 505B may not occur simultaneously, a standard voltage regulator may accommodate the total current of the system 100 at any given time.

In exemplary embodiments, the time delay Δt 507 between the first waveform 500A and the second waveform 500B may be between 2 and 111 microseconds, which may create a minimal delay in the amount of time the system 100 requires to program the stacked memory arrays 115, as compared to the seconds added if the write state machines 105 were to be programmed sequentially. Additionally, by creating a time-delay Δt 507 between the two waveforms 505A and 505B applied to the two write state machines 105, the overall cost of manufacturing and operating the system 100 may decrease as compared to the cost of manufacturing and operating a system in which the write state machines 105 are programmed in parallel (i.e., simultaneously). This is due in part to the fact that in many cases, a new regulator

should be added to the system to accommodate the larger amounts of current and in part to the fact that a lesser amount of current may be applied simultaneously.

[0026] FIG. 6 is a timing diagram illustrating a pair of current waveforms 600A and 600B for programming a stacked memory array 115 in accordance with still another embodiment of the present invention. Waveforms 600A and 600B may include a series of pulses 605 therein wherein all pulses 605 may be of equal amplitude, duration, and period. In an exemplary embodiment, the pulse generator 120 may apply the first pulse 605A₁ of current of the first waveform 600A, to the first write state machine 105A. Then, the delay circuit 125 may inject a time-delay Δt before the pulse generator 120 may apply a first pulse 605B₁ of current of the second waveform 600B to the second write state machine 105B. Therefore, in an exemplary embodiment, the second initial pulse 605B₁ may occur during the time of a first delay 610A₁ of the first waveform 600A, and thus, in an exemplary embodiment, the second waveform 600B may be delayed a period equal to Δt.

[0027] Other alternative embodiments will become apparent to those skilled in the art to which an exemplary embodiment pertains without departing from its spirit and scope. Accordingly, the scope of the embodiments of the present invention may be defined by the appended claims rather than the foregoing description.